

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Chip beads

For general signal line GHz noise countermeasure (general signal line, high-speed line)

MMZ-E series (for automobiles)

MMZ1005-E Type

MMZ1005-E 1005[0402 inch]*

* Dimensions code JIS[EIA]

Reminders for using these products

Before using these products, be sure to request the delivery specifications.

Safety reminders

Please pay sufficient attention to the warnings for safe designing when using this products.

⚠ Reminders
The storage period is less than 12 months.Be sure to follow the storage conditions (temperature:5 to 40°C, humidity:10 to 75% RH or less).
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
On not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
 Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
 Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
 Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference.
Use a wrist band to discharge static electricity in your body through the grounding wire.
On not expose the products to magnets or magnetic fields.
On not use for a purpose outside of the contents regulated in the delivery specifications.
The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property

- (1) Aerospace/aviation equipment
- (2) Transportation equipment (electric trains, ships, etc.)

set forth in the each catalog, please contact us.

- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions



Chip beads

For general signal line

Product compatible with RoHS directive
Halogen-free
Compatible with lead-free solders
AEC-Q200

GHz noise countermeasure (general signal line, high-speed line)

Overview of MMZ1005-E type

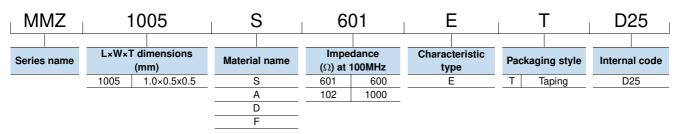
FEATURES

- Noise reduction solution for general signal line.
- Ocompared to the MMZ series, it is a product that increases the SRF to GHz bands and can countermeasure nose at wide frequencies with 1 element.
- O Compared to the MMZ series, it can attain high impedance at GHz bands.
- Ovarious frequency characteristics with 4 materials of different features for countermeasures against everything from general signals to high-speed signals.

APPLICATION

Various ECUs, various modules, car multimedia (telematics).

PART NUMBER CONSTRUCTION



OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

	Temperatu	ure ranges	Package quantity	Individual weight
Туре	Operating temperature	Storage temperature*		
	(°C)	(°C)	(pieces/reel)	(mg)
MMZ1005-E	-55 to +125	-55 to +125	10,000	1

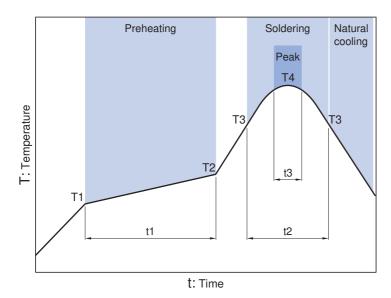
^{*} The storage temperature range is for after the circuit board is mounted.

OROHS Directive Compliant Product: See the following for more details.https://product.tdk.com/info/en/environment/rohs/index.html

O Halogen-free: indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.



■ RECOMMENDED REFLOW PROFILE



Preheatin	ng		Soldering		Peak	
Temp.		Time	Temp.	Time	Temp.	Time
T1	T2	t1	Т3	t2	T4	t3
150°C	180°C	60 to 120s	230°C	30 to 60s	250 to 260°C	10s



■ MATERIAL CHARACTERISTIC

S material: Standard type that features impedance characteristics similar to those of a typical ferrite core. For signal line applications in which the blocking region is near 100MHz. Impedance values selected for effectiveness at 40 to 300MHz.

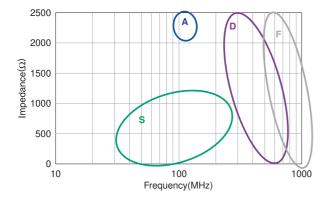
A material: This high-impedance product is based on the impedance frequency characteristics of our Y-material. The product offers excellent impedance characteristics, which is greater than 2500Ω , in the vicinity of 100MHz range (MMZ1608A252B).

D material: For applications calling for low insertion loss at low frequencies and sharply increasing impedance at high frequencies.

Designed for high impedance at high frequencies (300MHz to 1GHz) for signal line applications.

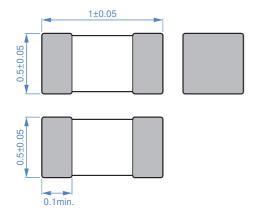
F material: This new product inherits the characteristic of our D-material, namely its sharp impedance rise time, and its impedance peak frequency has been shifted higher into range. The product offers excellent noise suppression from 600MHz to as high as in the GHz range.

TYPICAL MATERIAL IMPEDANCE CHARACTERISTICS





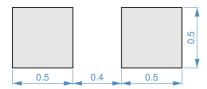
SHAPE & DIMENSIONS





Dimensions in mm

■ RECOMMENDED LAND PATTERN



Dimensions in mm



■ ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

Impedance				DC resistance	Rated current	Part No.
[100MHz]		[1GHz]				
(Ω)	Tolerance	(Ω)	Tolerance	(Ω)max.	(mA)max.	
600	±25%	1000	±40%	0.65	300	MMZ1005S601ETD25
1000	±25%	1400	±40%	1.00	250	MMZ1005S102ETD25
1800	±25%	1800	±40%	1.50	200	MMZ1005S182ETD25
600	±25%	1400	±40%	0.80	300	MMZ1005A601ETD25
1000	±25%	2000	±40%	1.20	250	MMZ1005A102ETD25
1500	±25%	2300	±40%	1.60	230	MMZ1005A152ETD25
1800	±25%	2700	±40%	2.10	200	MMZ1005A182ETD25
2200	±25%	3000	±40%	2.20	150	MMZ1005A222ETD25
120	±25%	1000	±40%	0.70	300	MMZ1005D121ETD25
220	±25%	1700	±40%	1.00	250	MMZ1005D221ETD25
47	±25%	800	±40%	0.70	300	MMZ1005F470ETD25
75	±25%	1500	±40%	1.00	250	MMZ1005F750ETD25
120	±25%	2300	±40%	1.50	200	MMZ1005F121ETD25
180	±25%	3200	±40%	1.60	200	MMZ1005F181ETD25
220	±25%	5000	±40%	2.30	150	MMZ1005F221ETD25

O Measurement equipment

Measurement item	Product No.	Manufacturer
Impedance	E4991A+16192A	Keysight Technologies
DC resistance	Type-7556	Yokogawa

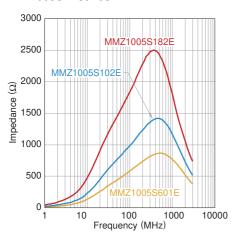
^{*} Equivalent measurement equipment may be used.



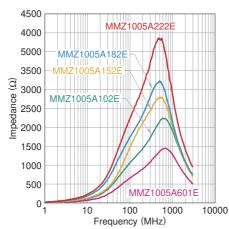
ELECTRICAL CHARACTERISTICS

□Z VS. FREQUENCY CHARACTERISTICS (BY SERIES)

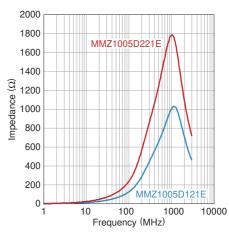
MMZ1005S-E series



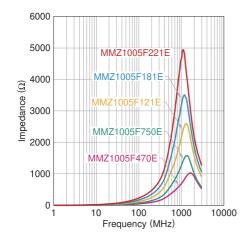
MMZ1005A-E series



MMZ1005D-E series



MMZ1005F-E series

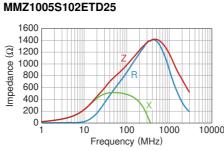


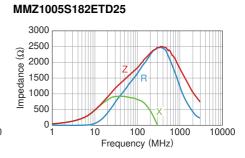
ELECTRICAL CHARACTERISTICS

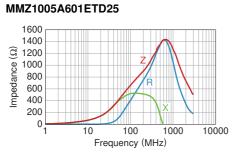
MMZ1005S601ETD25

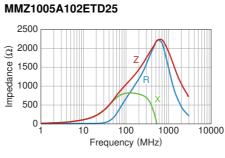
Z, X, R VS. FREQUENCY CHARACTERISTICS

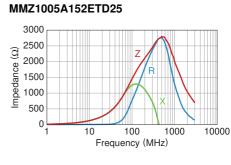
1000 (G) 800 800 600 200 1000 1000 1000 1000 Frequency (MHz)

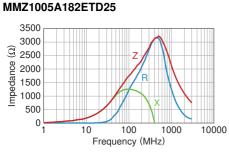


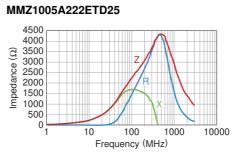


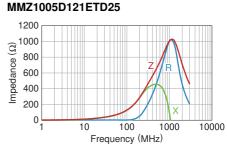


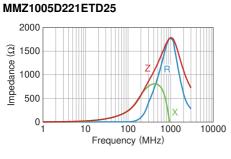


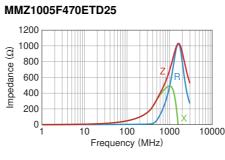


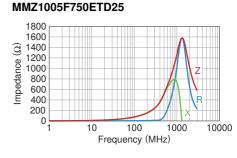


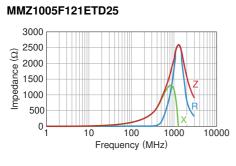


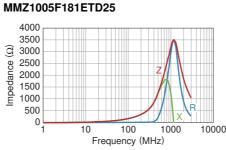


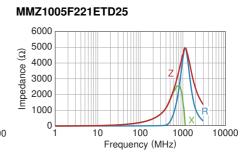










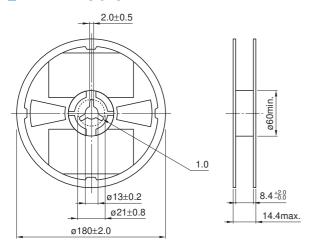


A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.



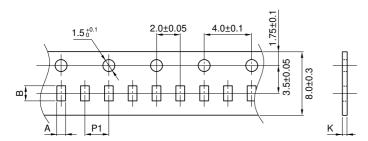
■PACKAGING STYLE

REEL DIMENSIONS



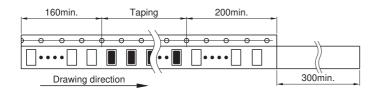
Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm

Туре	Α	В	P1	K
MMZ1005-E	0.65±0.1	1.15±0.1	2.0±0.05	0.8max.



Dimensions in mm